RENESAS

HAT2200R

Silicon N Channel Power MOS FET Power Switching

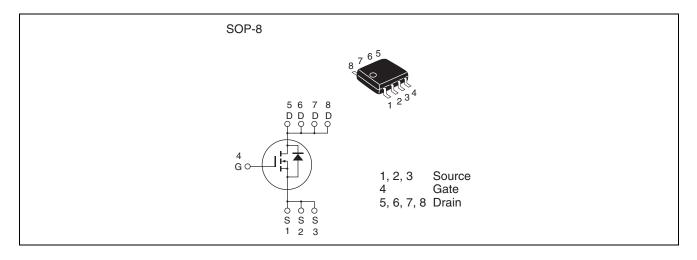
REJ03G0232-0200Z Rev.2.00 Apr.05.2004

Features

- Capable of 8 V gate drive
- Low drive current
- High density mounting
- Low on-resistance

 $R_{DS(on)} = 22 \text{ m}\Omega \text{ typ.} (at V_{GS} = 10 \text{ V})$

Outline





Absolute Maximum Ratings

| | | | | $(Ta = 25^{\circ}C)$ |
|--|------------------------|-------------|------|----------------------|
| Item | Symbol | Ratings | Unit | |
| Drain to source voltage | V _{DSS} | 100 | V | |
| Gate to source voltage | V _{GSS} | ±20 | V | |
| Drain current | I _D | 8 | А | |
| Drain peak current | Note1 D(pulse) | 64 | А | |
| Body-drain diode reverse drain current | I _{DR} | 8 | А | |
| Avalanche current | I _{AP} Note 2 | 8 | А | |
| Avalanche energy | E _{AR} Note 2 | 6.4 | mJ | |
| Channel dissipation | Pch Note3 | 2.5 | W | |
| Channel to Ambient Thermal Impedance | θch-a ^{Note3} | 50 | °C/W | |
| Channel temperature | Tch | 150 | °C | |
| Storage temperature | Tstg | –55 to +150 | °C | |

Notes: 1. PW \leq 10 $\mu s,\,duty\,cycle \leq$ 1%

2. Value at Tch = 25°C, Rg \geq 50 Ω

3. When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), PW \leq 10s

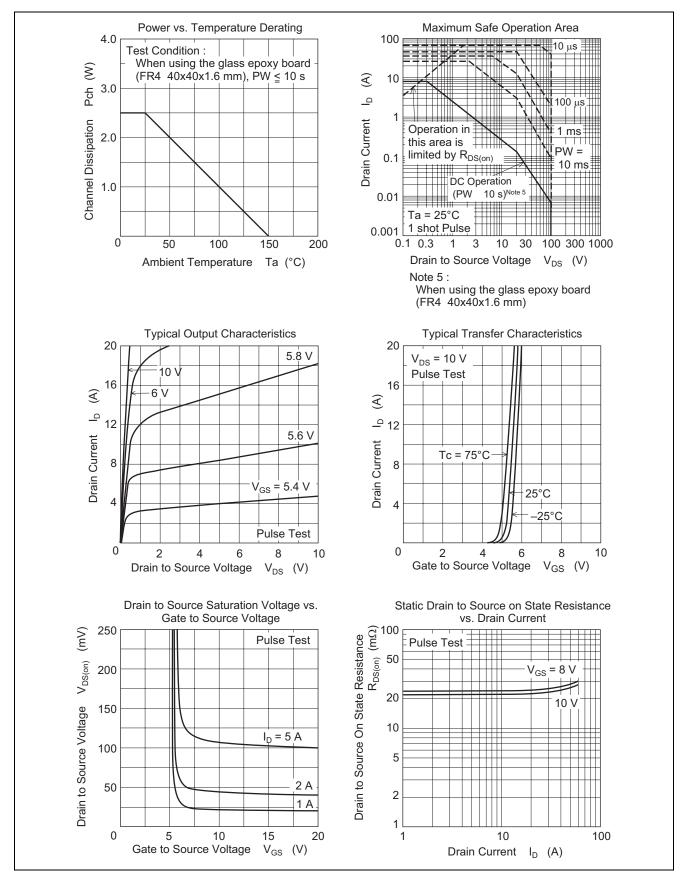
Electrical Characteristics

| | | | | | | $(Ta = 25^{\circ}C)$ |
|--|----------------------|-----|------|-------|------|---|
| Item | Symbol | Min | Тур | Max | Unit | Test Conditions |
| Drain to source breakdown voltage | V _{(BR)DSS} | 100 | _ | _ | V | $I_D = 10 \text{ mA}, V_{GS} = 0$ |
| Gate to source leak current | I _{GSS} | | _ | ± 0.1 | μΑ | $V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0$ |
| Zero gate voltage drain current | I _{DSS} | _ | _ | 1 | μΑ | $V_{DS} = 100 \text{ V}, V_{GS} = 0$ |
| Gate to source cutoff voltage | V _{GS(off)} | 3.5 | _ | 5.0 | V | $V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ mA}$ |
| Static drain to source on state | R _{DS(on)} | _ | 22 | 28 | mΩ | $I_D = 4 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note4}}$ |
| resistance | R _{DS(on)} | _ | 23 | 33 | mΩ | $I_D = 4 \text{ A}, V_{GS} = 8 \text{ V}^{Note4}$ |
| Forward transfer admittance | y _{fs} | 8 | 14 | _ | S | $I_D = 4 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note4}}$ |
| Input capacitance | Ciss | _ | 2300 | _ | pF | V _{DS} = 10 V |
| Output capacitance | Coss | _ | 280 | _ | pF | $V_{GS} = 0$ |
| Reverse transfer capacitance | Crss | _ | 90 | _ | pF | f = 1 MHz |
| Gate Resistance | Rg | _ | 1.3 | _ | Ω | |
| Total gate charge | Qg | _ | 32 | _ | nC | V _{DD} = 50 V |
| Gate to source charge | Qgs | _ | 12 | _ | nC | V _{GS} = 10 V |
| Gate to drain charge | Qgd | _ | 8 | _ | nC | $I_D = 8 \text{ A}$ |
| Turn-on delay time | t _{d(on)} | _ | 16 | _ | ns | $V_{GS} = 10 \text{ V}, \text{ I}_{D} = 4 \text{ A}$ |
| Rise time | t _r | _ | 4 | _ | ns | $V_{DD} \cong 30 \text{ V}$ |
| Turn-off delay time | t _{d(off)} | _ | 32 | _ | ns | $R_{L} = 7.5 \Omega$ |
| Fall time | t _f | _ | 4.5 | _ | ns | Rg = 4.7 Ω |
| Body-drain diode forward voltage | V_{DF} | _ | 0.79 | 1.03 | V | $IF = 8 A, V_{GS} = 0^{Note4}$ |
| Body-drain diode reverse recovery time | e t _{rr} | _ | 45 | _ | ns | IF = 8 A, V _{GS} = 0 |
| | | | | | | diF/ dt = 100 A/ µs |

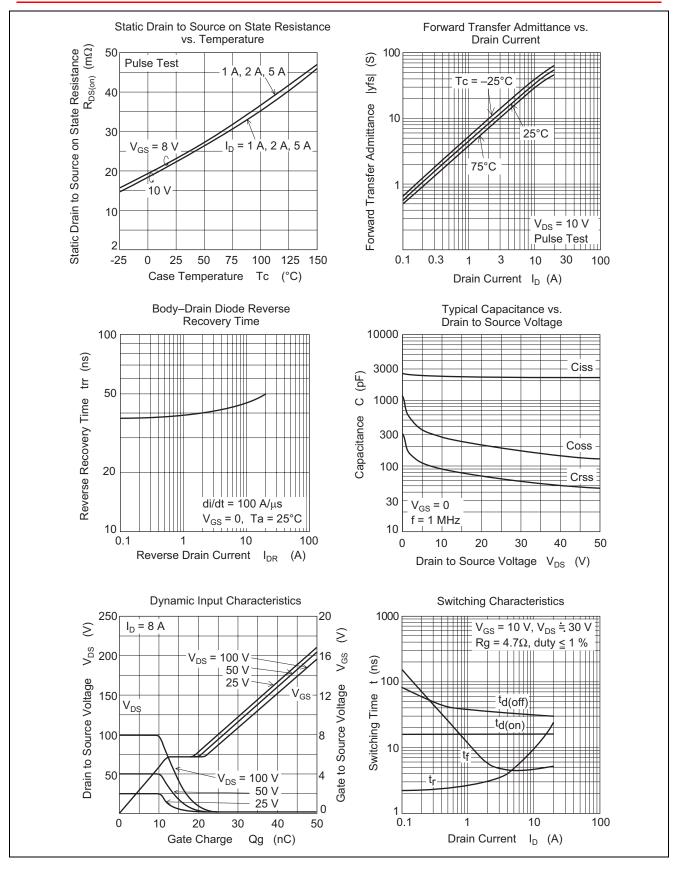
Notes: 4. Pulse test



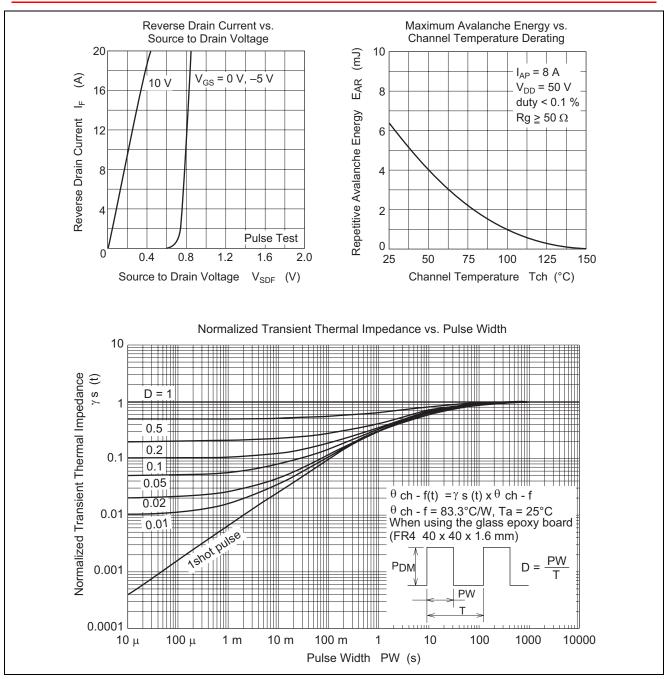
Main Characteristics



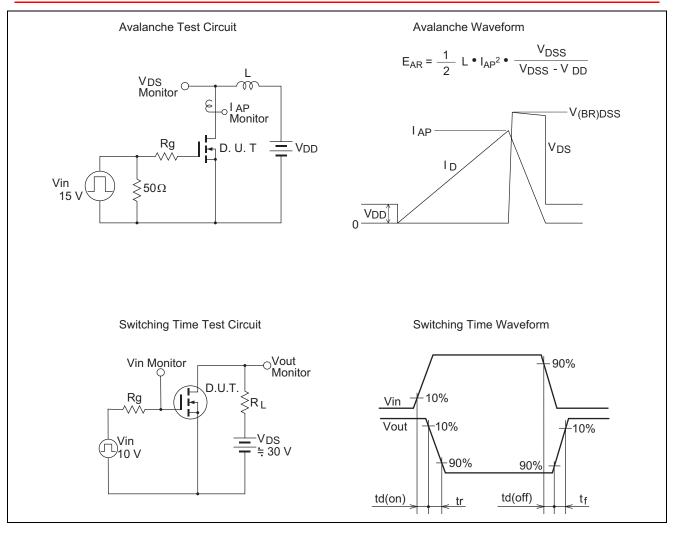






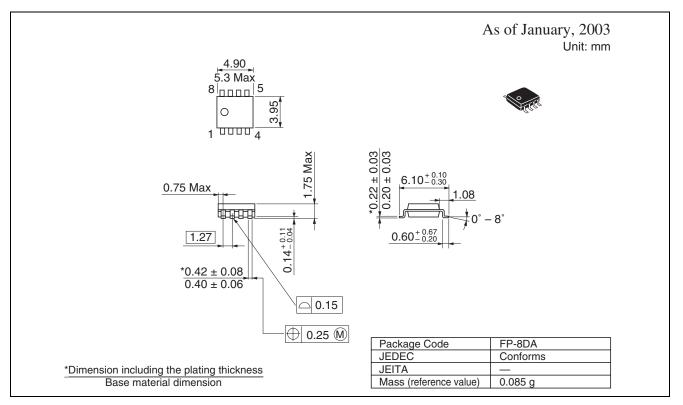


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Package Dimensions



Ordering Information

| Part Name | Quantity | Shipping Container | |
|---------------|----------|--------------------|--|
| HAT2200R-EL-E | 2500pcs | Taping | |
| | | | |

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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